

Pb Free Plating Product

GF2045MC thru GF20200MC



20.0 Ampere Surface Mount PhotoVoltaic Bypass Schottky Barrier Rectifier

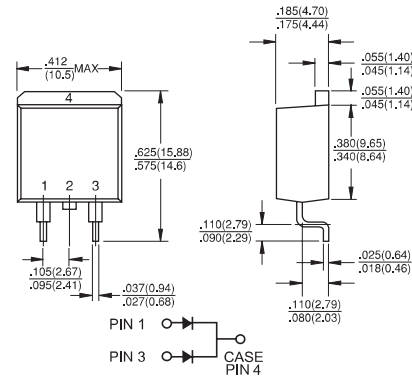
Features

- ✧ For surface mounted application
- ✧ Plastic material used carries Underwriters Laboratory Classifications 94V-0
- ✧ Metal silicon junction, majority carrier conduction
- ✧ Low power loss, high efficiency
- ✧ High current capability, low forward voltage drop
- ✧ High surge capability
- ✧ For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- ✧ Guardring for overvoltage protection
- ✧ High temperature soldering guaranteed: 260°C/10 seconds at terminals

Mechanical Data

- ✧ Cases: JEDEC D²PAK /TO-263-2L molded plastic
- ✧ Terminals: Pure tin plated, lead free. solderable per MIL-STD-750, Method 2026
- ✧ Polarity: As marked
- ✧ Mounting position: Any
- ✧ Mounting torque: 5 in. - lbs. max
- ✧ Weight: 0.06 ounce, 1.70 grams

D²PAK



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.
 Single phase, half wave, 60 Hz, resistive or inductive load.
 For capacitive load, derate current by 20%

Type Number	Symbol	GF2045MC	GF2060MC	GF20100MC	GF20200MC	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	45	60	100	200	V
Maximum RMS Voltage	V_{RMS}	31	42	70	140	V
Maximum DC Blocking Voltage	V_{DC}	45	60	100	200	V
Maximum Average Forward Rectified Current at $T_c=135^\circ\text{C}$	$I_{(AV)}$	20				A
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20KHz) at $T_c=135^\circ\text{C}$	I_{FRM}	20				A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	150				A
Peak Repetitive Reverse Surge Current (Note 1)	I_{RRM}	1.0	0.5			A
Maximum Instantaneous Forward Voltage at (Note 2) $I_F=10\text{A}, T_C=25^\circ\text{C}$ $I_F=10\text{A}, T_C=125^\circ\text{C}$ $I_F=20\text{A}, T_C=25^\circ\text{C}$ $I_F=20\text{A}, T_C=125^\circ\text{C}$	V_F	- 0.57 0.84 0.72	0.80 0.70 0.95 0.85	0.85 0.75 0.95 0.85	0.99 0.87 1.23 1.10	V
Maximum Instantaneous Reverse Current @ $T_c=25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_c=125^\circ\text{C}$	I_R	0.1 15	0.1 10			5.0 mA mA
Voltage Rate of Change, (Rated V_R)	dV/dt	10,000				V/ μS
Typical Junction Capacitance	C_j	400	320			pF
Typical Thermal Resistance Per Leg (Note 3)	$R_{\theta JC}$	1.0			2.0	$^\circ\text{C}/\text{W}$
Operating Junction Temperature Range	T_J	-65 to +150				$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +175				$^\circ\text{C}$

Notes: 1. 2.0us Pulse Width, f=1.0 KHz
 2. Pulse Test: 300us Pulse Width, 1% Duty Cycle
 3. Thermal Resistance from Junction to Case Per Leg, with Heatsink Size (4"x6"x0.25") Al-Plate.

FIG.1- FORWARD CURRENT DERATIN CURVE

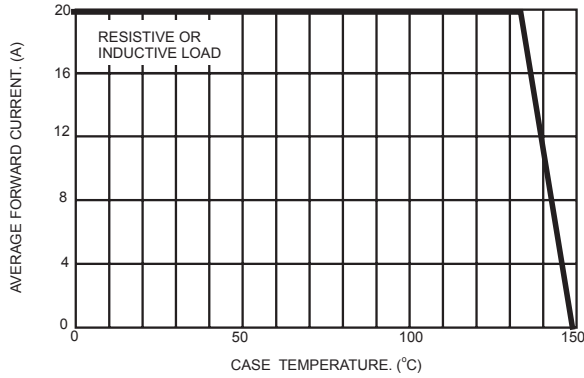


FIG.2- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG

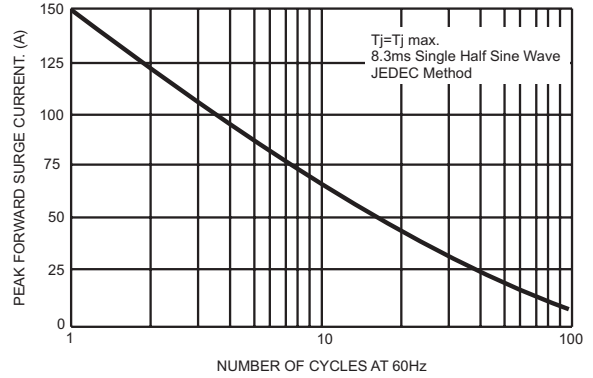


FIG.3- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS PER LEG

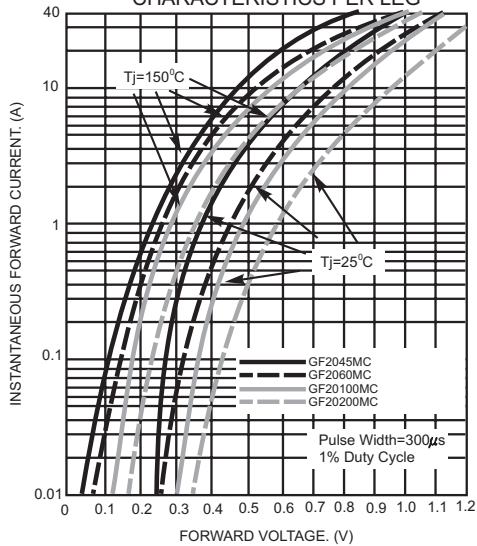


FIG.4- TYPICAL REVERSE CHARACTERISTICS PER LEG

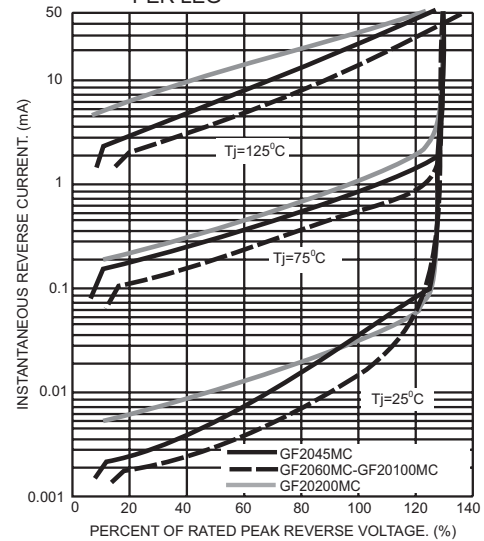


FIG.5- TYPICAL JUNCTION CAPACITANCE PER LEG

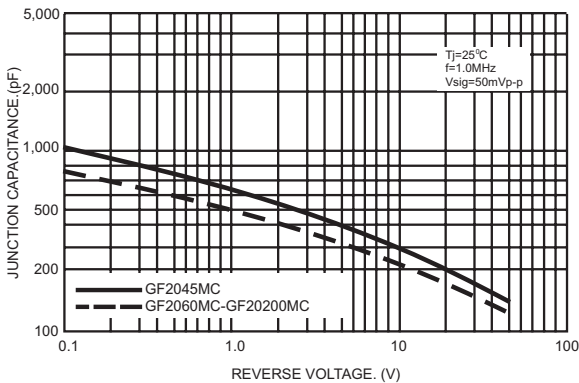


FIG.6- TYPICAL TRANSIENT THERMAL IMPEDANCE PER LEG

